INTEGRATED CIRCUITS

DATA SHEET

74LVT32 3.3V Quad 2-input OR gate

Product specification

1996 Aug 28

IC24 Data Handbook



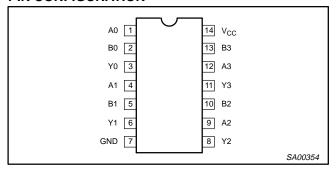


74LVT32

QUICK REFERENCE DATA

SYMBOL	PARAMETER	TYPICAL	UNIT	
^t PLH ^t PHL	Propagation delay An, Bn to Yn	$C_L = 50pF;$ $V_{CC} = 3.3V$	2.6 3.2	ns
C _{IN}	Input capacitance	V _I = 0V or 3.0V	3	pF
I _{CCL}	Total supply current	Outputs Low; V _{CC} = 3.6V	1	mA

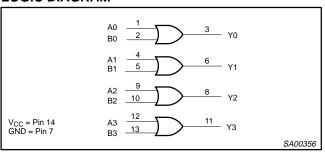
PIN CONFIGURATION



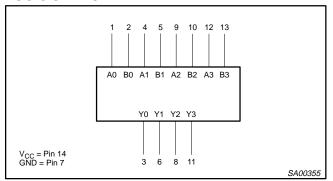
PIN DESCRIPTION

PIN NUMBER	SYMBOL NAME AND FUNCTION						
1, 2, 4, 5, 9, 10, 12, 13	An, Bn	Data inputs					
3, 6, 8, 11	Yn	Data outputs					
7	GND	Ground (0V)					
14	V _{CC}	Positive supply voltage					

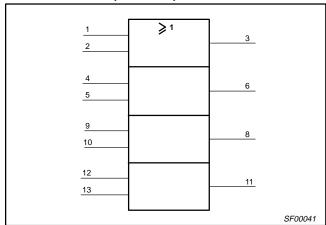
LOGIC DIAGRAM



LOGIC SYMBOL



LOGIC SYMBOL (IEEE/IEC)



FUNCTION TABLE

INP	JTS	OUTPUT
Dna	Dnb	Qn
L	L	L
L	Н	Н
Н	L	Н
Н	Н	Н

NOTES:

H = High voltage levelL = Low voltage level

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER	
TAGRAGEO	TEMI ENATORE RANGE	OUTOIDE NORTH AMERICA	NORTH AMERICA	DIVO NOMBER	
14-Pin Plastic SO	–40°C to +85°C	74LVT32 D	74LVT32 D	SOT108-1	
14-Pin Plastic SSOP	-40°C to +85°C	74LVT32 DB	74LVT32 DB	SOT337-1	
14-Pin Plastic TSSOP	-40°C to +85°C	74LVT32 PW	74LVT32PW DH	SOT402-1	

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ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +4.6	V
I _{IK}	DC input diode current	V _I < 0	-50	mA
VI	DC input voltage ³		-0.5 to +7.0	V
lok	DC output diode current	V _O < 0	-50	mA
V _{OUT}	DC output voltage ³	Output in Off or High state	-0.5 to +7.0	V
	DC output outroot	Output in High state	-32	A
lout	DC output current	Output in Low state	64	mA
T _{stg}	Storage temperature range		-65 to 150	°C

NOTES:

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIM	UNIT	
STWIBUL	PARAMETER	MIN	MIN MAX	
V _{CC}	DC supply voltage	2.7	3.6	V
V _I	Input voltage	0	5.5	V
V_{IH}	High-level input voltage	2.0		V
V_{IL}	Low-level Input voltage		0.8	V
I _{OH}	High-level output current		-20	mA
I _{OL}	Low-level output current		32	mA
Δt/Δν	Input transition rise or fall rate; Outputs enabled		10	ns/V
T _{amb}	Operating free-air temperature range	-40	+85	°C

Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

3. The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

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DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions Voltages are referenced to GND (ground = 0V)

			L					
SYMBOL	PARAMETER	TEST CONDITIONS	Temp = -	40°C to	+85°C	UNIT		
			MIN	TYP ¹	MAX			
V _{IK}	Input clamp voltage	$V_{CC} = 2.7V; I_{IK} = -18mA$			-1.2	V		
		$V_{CC} = 2.7 \text{ to } 3.6 \text{V}; I_{OH} = -100 \mu\text{A}$	V _{CC} -0.2					
V _{OH}	High-level output voltage	$V_{CC} = 2.7V; I_{OH} = -6mA$	2.4			V		
		$V_{CC} = 3.0V; I_{OH} = -20mA$	2.0					
		$V_{CC} = 2.7V; I_{OL} = 100\mu A$			0.2			
V _{OL}	Low-level output voltage	$V_{CC} = 2.7V; I_{OL} = 24mA$			0.5	V		
		$V_{CC} = 3.0V; I_{OL} = 32mA$			0.5			
11	Input leakage current $V_{CC} = 0 \text{ or } 3.6V; V_I = 5.5V$				10	μА		
"	input leakage current	$V_{CC} = 3.6V$; $V_I = V_{CC}$ or GND		μΑ				
l _{OFF}	Output off current	$V_{CC} = 0V$; V_I or $V_O = 0$ to 4.5V			±100	μΑ		
Іссн	Quiescent supply current	V_{CC} = 3.6V; Outputs High, V_{I} = GND or V_{CC} , I_{O} = 0			0.02	mA		
I _{CCL}	Quiescent supply current	V_{CC} = 3.6V; Outputs Low, V_{I} = GND or V_{CC} , I_{O} = 0	1 2		ША			
Δl _{CC}	Additional supply current per input pin ²	V_{CC} = 3V to 3.6V; One input at V_{CC} –0.6V, Other inputs at V_{CC} or GND			0.2	μА		
C _I	Input capacitance	$V_I = 3V \text{ or } 0$		3		pF		

- All typical values are at V_{CC} = 3.3V and T_{amb} = 25°C.
 This is the increase in supply current for each input at the specificed voltage level other than V_{CC} or GND.

AC CHARACTERISTICS

GND = 0V; $t_R = t_F = 2.5 \text{ns}$; $C_L = 50 \text{pF}$, $R_L = 500 \Omega$; $T_{amb} = -40 ^{\circ} \text{C}$ to $+85 ^{\circ} \text{C}$.

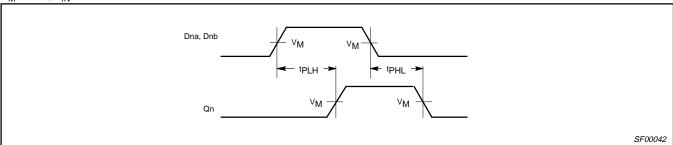
SYMBOL	PARAMETER	WAVEFORM	V _C	$= 3.3 V \pm 0$	V _{CC} = 2.7V	UNIT		
			MIN	TYP ¹	MAX	MAX		
t _{PLH} t _{PHL}	Propagation delay An, Bn to Yn	1	1.0 1.0	2.6 3.2	3.8 4.6	4.5 4.9	ns	

NOTE:

1. All typical values are at V_{CC} = 3.3V and T_{amb} = 25°C.

AC WAVEFORMS

 $V_M = 1.5V$, $V_{IN} = GND$ to 2.7V

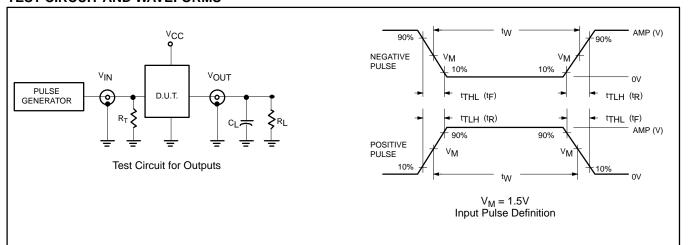


Waveform 1. Propagation delay for inverting outputs

3.3V Quad 2-input OR gate

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TEST CIRCUIT AND WAVEFORMS



DEFINITIONS

 R_L = Load resistor; see AC CHARACTERISTICS for value.

 $C_L = Load$ capacitance includes jig and probe capacitance; see AC CHARACTERISTICS for value.

FAMILY	INPUT PULSE REQUIREMENTS											
	Amplitude	Rep. Rate	t _W	t _R	t _F							
74LVT	2.7V	≤10MHz	500ns	≤2.5ns	≤2.5ns							

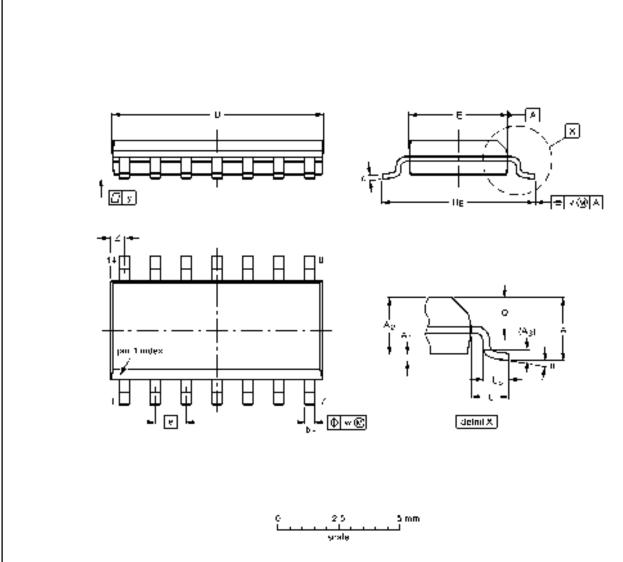
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SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



DIMENSIONS (Inch dimensions are derived from the original men dimensions)

UNIT	A max.	4,	Ąz	43	å	ų	on)	€ [□]	•	ĦE	١	Lp	Ģ	>	4	*	Z (0)	11
mm	1.75	0. 25 0.10	145 125	0.25	0.45 0.00	0.25 0.19	8.75 8.∞	4.0 3.0	1 27	52 58	į	1.0 U,a	0.7 0.6	0 25	0.25	01	07 03	B°
inches		00048 00039		0.61	0 018 0 014	0.0049 0.0075		0 15 0 15	0.050	0.23 0.23	0.041	0.008	0.028 0.024	0 01	0.01	0 994	0+29 0012	05

Note

1. Healistor metal profusions of 0.15 mm maximum per side are not included

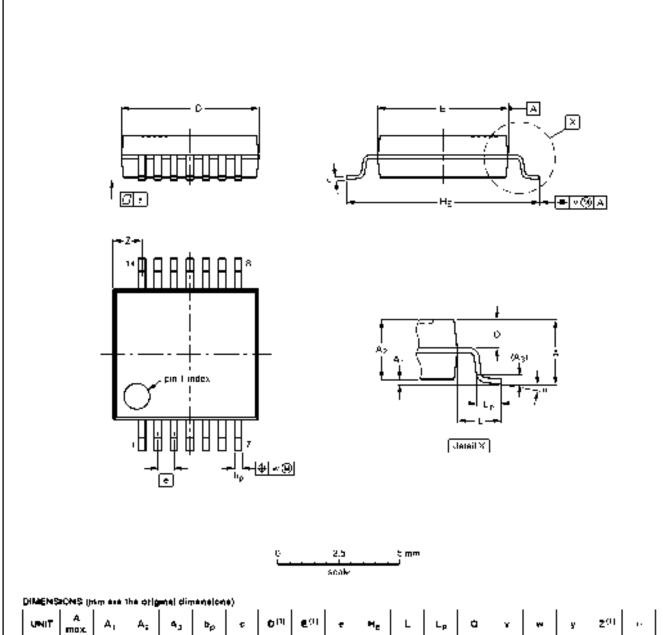
OUTLINE		REFER	EUROPEAN	IBBUE DATE	
YERBION	IEC	1EDE¢	EITJ	PROJECTION	IBBGE DATE
SOT108-1	076E06S	M5-012AB		□ ◎	91 08 19 95-01-29

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SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1



UNIT	A mox.	Α,	A:	4,	ρþ	£	Olul	€01	•	HE	L	Lp	à	٧	~	y	201	1.
mm	20	0.21 0.05	180 165	0.25	0.08 0.25	0.20 0.09	670	4 :2 6 :3	0.65	70 76	125	1.03 0.63	0.9 0.7	02	0.10	9.1	14 09	n,

Nose

1. Plastic or metal profusions of 0.25 mm maximum particle are not included

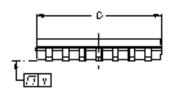
OUTLINE		REFER	RENCES	EUROPEAN	IBBUE DATE		
YERBION	IEC	JEDE¢	EIT1		PROJECTION	IBOUEDATE	
SOT007-1		MO-150AB				95 82 94 96-01-19	

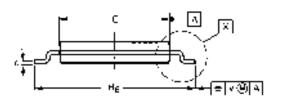
3.3V Quad 2-input OR gate

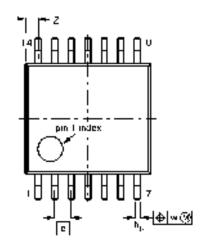
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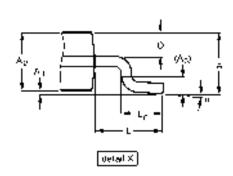
TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

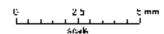
SOT402-1











DIMENSIONS (mm are the original dimensions)

UNIT	A XEM	4,	Α,	۵,	b _p	٠	ьm	€ /21	•	H e	L	L _P	a	v	₩.	¥	Z (0)	"	
mm	1.10	0.15 0.05	0.03 0.80	0.25	0.00 0.19	07	5.1 4.9	4.5 a,y	055	66 02	1.0	0.75 0.59	0.4 0.3	02	0 13	0.1	0.72 0.38	es Os	

Notes

- 1. Plastic or metal profitusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead provisions of 0.25 mm maximum per side are not included

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
YERSION	IEC	JEDEC	PROJECTION			
SQT402-1		MO-150				- 94 07 42 95-14-04

3.3V Quad 2-input OR gate

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NOTES

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3.3V Quad 2-input OR gate

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DEFINITIONS						
Data Sheet Identification	Product Status	Definition				
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.				
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